





Parameter	Rating	Units
Breakdown Voltage - BV _{CEO}	350	V _P
Current Transfer Ratio - CTR	1000-8000	%

Features

- ullet 3750V $_{
 m rms}$ Input/Output Isolation
- Machine Insertable, Wave Solderable
- Surface Mount Tape & Reel Version Available
- 350V_P Breakdown Voltage

Applications

- Telecom Switching
- Tip/Ring Circuits
- Modem Switching (Laptop, Notebook, Pocket Size)
- Loop Detect
- Ringing Detect
- Current Sensing

Description

The CPC1302 is a dual optocoupler with two identical, independent channels, each having a unidirectional input and a high-voltage Darlington output. Light output from the highly efficient GaAlAs infrared LED activates its associated, optically coupled silicon NPN photo-Darlington output transistor. The input LED and the output transistor are separated by a $3750V_{\rm rms}$ isolation barrier.

With an LED current of only 1mA, a current transfer ratio of 1000% to 8000% is guaranteed at the collector of the 350V Darlington output transistor.

The CPC1302's low input current capability with high current transfer ratios, output voltage capability, and isolation barrier rating make it ideal for many applications such as telecom, industrial, and power control.

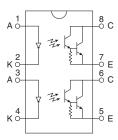
Approvals

- UL Recognized: File # E76270
- CSA Certified: File # 156092 (LR436.39)
- EN/IEC 60950-1 compliant

Ordering Information

Part Number	Description
CPC1302G	8-Pin DIP (50/Tube)
CPC1302GS	8-Pin Surface Mount (50/Tube)
CPC1302GSTR	8-Pin Surface Mount (1000/Reel)

Pin Configuration











Absolute Maximum Ratings

Parameter	Ratings	Units
Breakdown Voltage, BV _{CEO}	350	V _P
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	Α
Input Power Dissipation ¹	150	mW
Phototransistor Power Dissipation ²	150	mW
Isolation Voltage, Input to Output	3750	V _{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

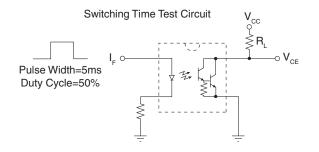
Electrical absolute maximum ratings are at 25°C

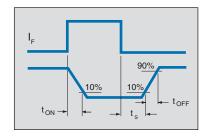
Electrical Characteristics

Parameters	Conditions	Symbol	Min	Тур	Max	Units
Output Characteristics @ 25°C				•		
Phototransistor Breakdown Voltage	I _{CEO} =100μA	BV _{CEO}	350	-	-	V _P
Phototransistor Output (Dark) Current	V _{CEO} =200V, I _F =0mA	I _{CEO}	-	-	100	nA
Saturation Voltage	n Voltage I _C =10mA, I _F =1mA -	-	-	1	V	
	I _C =100mA, I _F =10mA	V _{CE(sat)}	-	-	1.2	V
Current Transfer Ratio	I _F =1mA, V _{CE} =1V CTR 1000		1000	5500	8000	%
Output Capacitance	V _{CEO} =50V, f=1MHz	C _{OUT}	-	13	-	pF
Input Characteristics @ 25°C				•	'	•
Input Control Current	I _C =10mA, V _{CE} =1V	I _F	-	0.07	1	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Input Reverse Current	V _R =5V	I _R	-	-	10	μΑ
Common Characteristics @ 25°C		,			1	
Input to Output Capacitance	-	C _{I/O}	-	3	-	pF

Switching Characteristics @ 25°C

Characteristic	Symbol	Test Condition	Тур	Units	
Rise Time	t _R	V _10V	40		
Fall Time	t _F	V_{CC} =10V I_{F} =10mA R_{L} =100 Ω	5		
Turn-On Time	t _{ON}		5		
Turn-Off Time	t _{OFF}		60	μs	
Turn-On Time	t _{ON}	V _{CC} =10V	1		
Storage Time	t _S	I _F =16mA	40		
Turn-Off Time	t _{OFF}	$R_L=180\Omega$	80		



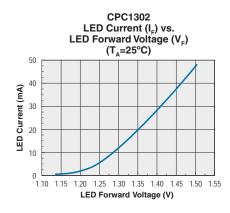


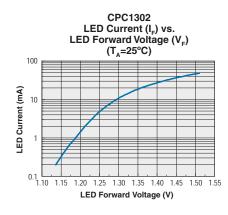
¹ Derate Linearly 1.33 mW/°C

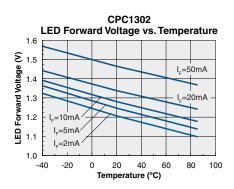
² Derate Linearly 1.5 mW/°C

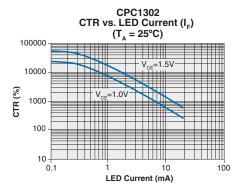


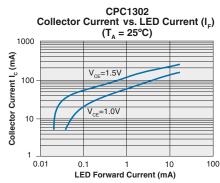
PERFORMANCE DATA*

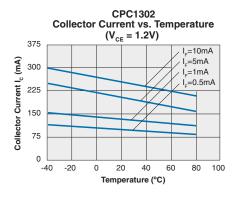


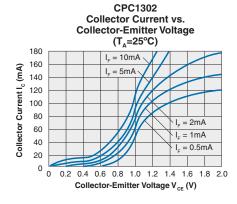


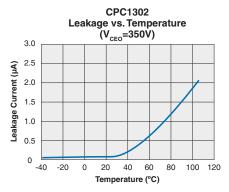


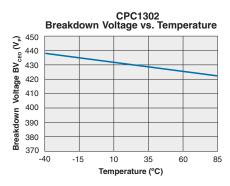


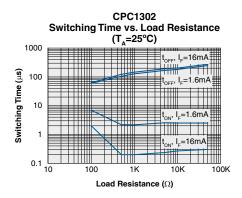












^{*}The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.



Manufacturing Information

Soldering

For proper assembly, the component must be processed in accordance with the current revision of IPC/JEDEC standard J-STD-020. Failure to follow the recommended guidelines may cause permanent damage to the device resulting in impaired performance and/or a reduced lifetime expectancy.

Washing

Clare does not recommend ultrasonic cleaning or the use of chlorinated solvents.

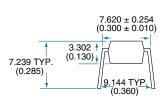


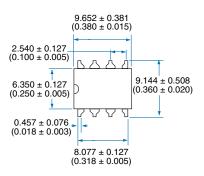




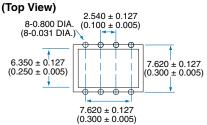
MECHANICAL DIMENSIONS

8-Pin DIP Through Hole (Standard)

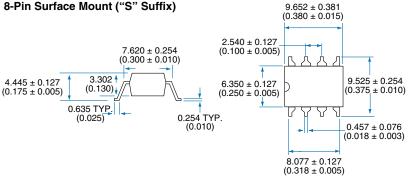




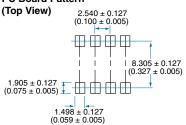
PC Board Pattern



8-Pin Surface Mount ("S" Suffix)



PC Board Pattern

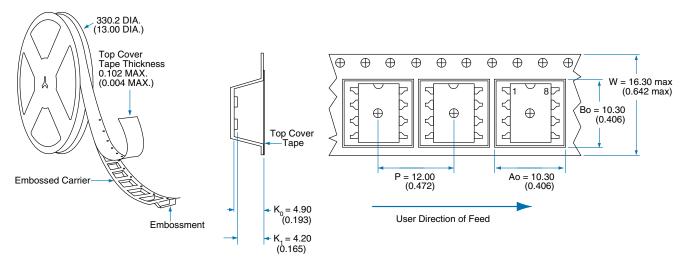


Dimensions: mm

(inches)



Tape and Reel Packaging for 8-Pin Surface Mount Package



NOTE: Tape dimensions not shown, comply with JEDEC Standard EIA-481-2

Dimensions: mm (inches)

For additional information please visit our website at: www.clare.com

Clare, Inc. makes no representations or warranties with respect to the accuracy or completeness of the contents of this publication and reserves the right to make changes to specifications and product descriptions at any time without notice. Neither circuit patent licenses nor indemnity are expressed or implied. Except as set forth in Clare's Standard Terms and Conditions of Sale, Clare, Inc. assumes no liability whatsoever, and disclaims any express or implied warranty, relating to its products including, but not limited to, the implied warranty of merchantability, fitness for a particular purpose, or infringement of any intellectual property right.

The products described in this document are not designed, intended, authorized or warranted for use as components in systems intended for surgical implant into the body, or in other applications intended to support or sustain life, or where malfunction of Clare's product may result in direct physical harm, injury, or death to a person or severe property or environmental damage. Clare, Inc. reserves the right to discontinue or make changes to its products at any time without notice.